

# 0.5 GHz to 4.0 GHz, GaAs, SPST Switch

**HMC1055 Data Sheet** 

#### **FEATURES**

Low insertion loss: 0.7 dB typical at 2.0 GHz High input third-order intercept (IP3): >60 dBm typical Single positive control: 0 V or 3 V Small, surface-mount, 8-lead, 2 mm × 2 mm LFCSP package

#### **APPLICATIONS**

**Cellular infrastructure** Wireless infrastructure **Mobile radios Test equipment** 

#### **FUNCTIONAL BLOCK DIAGRAM**

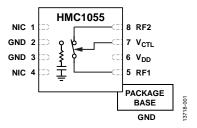


Figure 1.

#### **GENERAL DESCRIPTION**

The HMC1055 is a low cost, gallium arsenide (GaAs), singlepole, single-throw (SPST) switch in a surface-mount LFCSP package. This switch offers low insertion loss, high isolation, and exceptional third-order intermodulation performance that make it ideal for many cellular and wireless infrastructure applications from 0.5 GHz to 4.0 GHz.

The HMC1055 operates with single positive supply voltage and a single positive control voltage at very low dc currents. RF1 is reflective open, whereas RF2 is terminated to 50  $\Omega$  in the off state.

# **TABLE OF CONTENTS**

| e  |
|----|
| 8  |
|    |
| 9  |
| 9  |
| 9  |
| 10 |
| 10 |
|    |
|    |
| 5  |
| 5  |
| 5  |
| 6  |
| 7  |
| 8  |
|    |
| 9  |
| 10 |
|    |

# **SPECIFICATIONS**

 $V_{\text{DD}}$  = 3 V ,  $V_{\text{CTL}}$  = 0 V or  $V_{\text{DD}},$   $T_{\text{A}}$  = 25°C, 50  $\Omega$  system, unless otherwise noted.

#### Table 1.

| Parameter                         | Test Conditions/Comments                | Min | Тур | Max | Unit |
|-----------------------------------|---|-----|-----|-----|------|
| FREQUENCY                         |   | 0.5 |     | 4.0 | GHz  |
| INSERTION LOSS                    | 0.5 GHz to 2.0 GHz                      |     | 0.7 |     | dB   |
|                                   | 2.0 GHz to 4.0 GHz                      |     | 1.4 |     | dB   |
| ISOLATION                         | 0.5 GHz to 2.0 GHz                      |     | 36  |     | dB   |
|                                   | 2.0 GHz to 4.0 GHz                      |     | 28  |     | dB   |
| RETURN LOSS                       |   |     |     |     |      |
| On State                          | 0.5 GHz to 2.0 GHz, RF1 and RF2 ports   |     | 27  |     | dB   |
|                                   | 2.0 GHz to 4.0 GHz, RF1 and RF2 ports   |     | 25  |     | dB   |
| Off State                         | 0.5 GHz to 2.0 GHz, RF2 port            |     | 12  |     | dB   |
|                                   | 2.0 GHz to 4.0 GHz, RF2 port            |     | 24  |     | dB   |
| INPUT LINEARITY                   | 0.5 GHz to 4.0 GHz                      |     |     |     |      |
| Input 0.1 dB Compression (P0.1dB) |   |     | 28  |     | dBm  |
| Input Third-Order Intercept (IP3) | Two-tone input power = 15 dBm each tone |     | >60 |     | dBm  |
| SWITCHING CHARACTERISTICS         |   |     |     |     |      |
| Rise/Fall Time (trise, trall)     | 10% to 90% RF                           |     | 40  |     | ns   |
| On/Off Time (ton, toff)           | 50% V <sub>CTL</sub> to 90% RF          |     | 50  |     | ns   |
| CURRENT                           |   |     |     |     |      |
| Supply (I <sub>DD</sub> )         | $V_{DD} = 3 V \text{ to } 5 V$          |     | 0.2 |     | mA   |
| Control (I <sub>CTL</sub> )       | 0 V or V <sub>DD</sub>                  |     | <5  |     | μΑ   |

## **ABSOLUTE MAXIMUM RATINGS**

#### Table 2.

| Parameter  | Rating                                     |
|--|--|
| RF Input Power ( $V_{DD} = 3 \text{ V}, T_{CASE} = 85^{\circ}\text{C}$ ) | 34 dBm                                     |
| Supply Voltage   | 6.0 V                                      |
| Control Voltage Range  | $-0.2 \text{ V to V}_{DD} + 0.2 \text{ V}$ |
| Continuous Power Dissipation, PDISS                                      | 0.88 W                                     |
| Thermal Resistance, $\theta_{JC}$ (Channel to Package Bottom)            | 74°C/W                                     |
| Channel Temperature  | 150°C                                      |
| Operating Temperature Range  | -40°C to +85°C                             |
| Storage Temperature Range  | −65°C to +150°C                            |
| Reflow Temperature   | 260°C                                      |
| ESD Sensitivity, Human Body Model (HBM)                                  | 250 V (Class 1A)                           |

Stresses at or above those listed under Absolute Maximum Ratings may cause permanent damage to the product. This is a stress rating only; functional operation of the product at these or any other conditions above those indicated in the operational section of this specification is not implied. Operation beyond the maximum operating conditions for extended periods may affect product reliability.

#### **ESD CAUTION**



**ESD** (electrostatic discharge) sensitive device. Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

# PIN CONFIGURATION AND FUNCTION DESCRIPTIONS

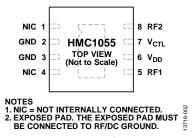


Figure 2. Pin Configuration

**Table 3. Pin Function Descriptions** 

| Pin No. | Mnemonic         | Description  |
|---------|------------------|--|
| 1, 4    | NIC              | Not Internally Connected. These pins are not internally connected but can be grounded.           |
| 2, 3    | GND              | Ground. These pins must be connected to RF ground.   |
| 5       | RF1              | RF Input. This pin is dc-coupled and matched to 50 $\Omega$ . A blocking capacitor is required.  |
| 6       | $V_{DD}$         | Supply Voltage Pin.  |
| 7       | V <sub>CTL</sub> | Control Input Pin.   |
| 8       | RF2              | RF Output. This pin is dc-coupled and matched to 50 $\Omega$ . A blocking capacitor is required. |
|         | EPAD             | Exposed Pad. The exposed pad must be connected to RF/dc ground.                                  |

#### **INTERFACE SCHEMATICS**



Figure 3. GND Interface Schematic

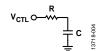


Figure 4. V<sub>CT</sub> Interface Schematic

## TYPICAL PERFORMANCE CHARACTERISTICS

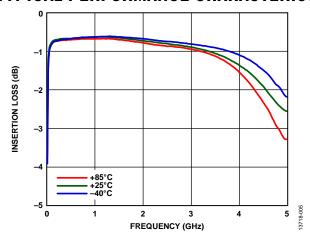


Figure 5. Insertion Loss vs. Frequency over Temperature,  $V_{DD} = 3 \text{ V}$ ,  $V_{CTL} = 3 \text{ V}$ 

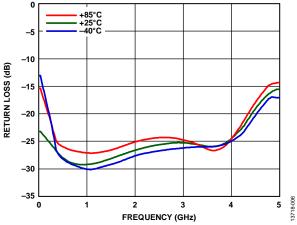


Figure 6. RF1 Return Loss vs. Frequency over Temperature,  $V_{DD}$  = 3 V,  $V_{CTL}$  = 3 V

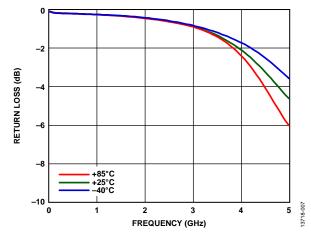


Figure 7. RF1 Return Loss vs. Frequency over Temperature,  $V_{\text{DD}}$  = 3 V,  $V_{\text{CTL}}$  = 0 V

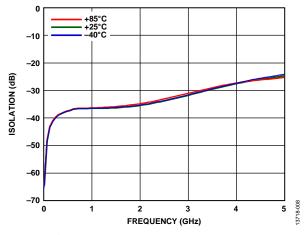


Figure 8. Isolation vs. Frequency over Temperature,  $V_{DD} = 3 V$ ,  $V_{CTL} = 0 V$ 

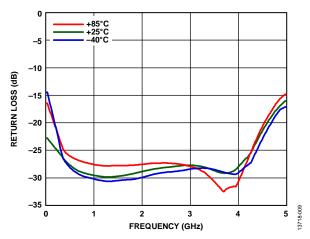


Figure 9. RF2 Return Loss vs. Frequency over Temperature,  $V_{DD} = 3 V$ ,  $V_{CTL} = 3 V$ 

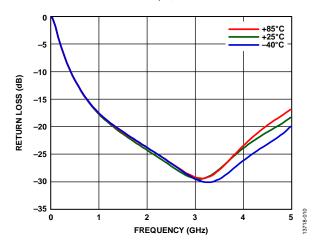


Figure 10. RF2 Return Loss vs. Frequency over Temperature,  $V_{DD} = 3 V$ ,  $V_{CTL} = 0 V$ 

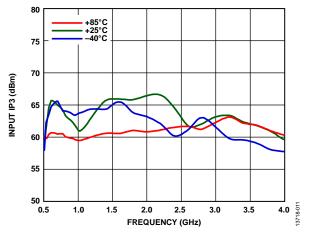


Figure 11. Input IP3 vs. Frequency Over Temperature,  $V_{DD} = 3 V$ ,  $V_{CTL} = 3 V$ 

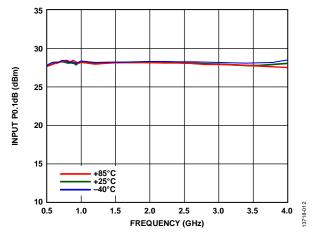


Figure 12. Input P0.1dB vs. Frequency Over Temperature,  $V_{DD} = 3 V$ ,  $V_{CTL} = 3 V$ 

### THEORY OF OPERATION

The HMC1055 requires a single-supply voltage applied to the  $V_{\text{\tiny DD}}$  pin. Bypassing capacitors are recommended on the supply line to minimize RF coupling.

The HMC1055 is controlled via a single digital control voltage applied to the  $V_{\rm CTL}$  pin. When the  $V_{\rm CTL}$  pin is high, the switch is set to the on state, by which an insertion loss path is provided from RF1 to RF2. When the  $V_{\rm CTL}$  pin is low, the switch is set to the off state, by which RF2 is isolated from RF1 and terminated to 50  $\Omega$ , whereas RF1 becomes reflective open (see Table 4).

The HMC1055 is internally matched to 50  $\Omega$  at the RF1 and RF2 pins; therefore, no external matching components are required. The RF1 and RF2 pins are dc-coupled, and dc blocking capacitors are required on the RF lines.

**Table 4. Truth Table** 

| Supply Voltage<br>(V <sub>DD</sub> ) | Control Voltage<br>(V <sub>CTL</sub> ) <sup>1</sup> | Switch Mode<br>(RF1 to RF2) |
|--------------------------------------|---|-----------------------------|
| 3 V                                  | 0 V   | Off                         |
|                                      | 3 V   | On                          |
| 5 V                                  | 0 V   | Off                         |
|                                      | 5 V   | On                          |

 $<sup>^{1}</sup>$  Control voltage tolerances are  $\pm 0.2$  V dc.

# APPLICATIONS INFORMATION EVALUATION PRINTED CIRCUIT BOARD (PCB)

The HMC1055 evaluation board is constructed of a 4-layer material with a copper thickness of 0.7 mil on each layer. Every copper layer is separated with a dielectric material. The top dielectric material is 10 mil RO4350. The middle and bottom dielectric materials are FR-4, used for mechanical strength and overall board thickness of approximately 62 mil, which allows SMA connectors to be slipped in at the board edges.

All RF and dc traces are routed on the top copper layer. The RF transmission lines are designed using a coplanar waveguide (CPWG) model, with a width of 16 mil, spacing of 13 mil, and dielectric thickness of 10 mil, to have a characteristic impedance of 50  $\Omega$ . The inner and bottom layers are grounded planes to provide a solid ground for the RF transmission lines. For optimal electrical and thermal performance, as many vias as possible are arranged around the transmission lines and under the package exposed pad. The evaluation board layout shown in Figure 14 serves as a recommendation for optimal and stable performance, as well as for improvement of thermal efficiency.

The package ground pins are connected directly to the ground plane. The supply voltage and control voltage must be connected to the dc pins, J3 and J4, respectively, of the evaluation board. One decoupling capacitor is populated on the supply trace to filter high frequency noise.

The RF input and output ports (RF1 and RF2) are connected through 50  $\Omega$  transmission lines to the SMA connectors, J1 and J2, respectively. The RF1 and RF2 ports are ac-coupled with capacitors of an appropriate value to ensure broadband performance. A thru calibration line connects J5 and J6; this transmission line is used to estimate the loss of the PCB over the environmental conditions being evaluated.

#### **EVALUATION BOARD SCHEMATIC AND ARTWORK**

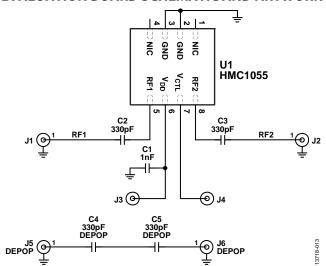


Figure 13. Evaluation Board Schematic

Table 5. List of Materials for EVAL01-HMC1055LP2C

| Item   | Description                    |
|--------|--------------------------------|
| J1, J2 | PCB mount, SMA, RF connector   |
| J3, J4 | DC pin                         |
| C1     | 1 nF capacitor, 0402 package   |
| C2, C3 | 330 pF capacitor, 0402 package |
| U1     | HMC1055 SPST switch            |
| PCB    | 600-00215-00-1 evaluation PCB  |

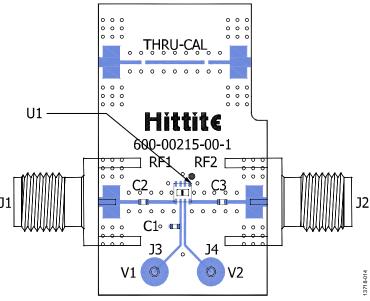


Figure 14. Evaluation Board Layout—Top View
Rev. B | Page 9 of 10

## **OUTLINE DIMENSIONS**

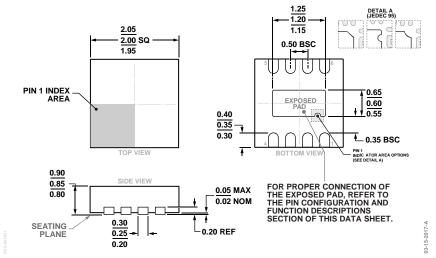


Figure 15. 8-Lead Lead Frame Chip Scale Package [LFCSP] 2 mm × 2 mm Body and 0.90 mm Package Height (CP-8-26) Dimensions shown in millimeters

#### **ORDERING GUIDE**

| Model <sup>1</sup> | Temperature Range | Package Description                          | Package Option |
|--------------------|-------------------|--|----------------|
| HMC1055LP2CE       | -40°C to +85°C    | 8-Lead Lead Frame Chip Scale Package [LFCSP] | CP-8-26        |
| HMC1055LP2CETR     | -40°C to +85°C    | 8-Lead Lead Frame Chip Scale Package [LFCSP] | CP-8-26        |
| EVAL01-HMC1055LP2C |                   | Evaluation Board                             |                |

<sup>&</sup>lt;sup>1</sup> All models are RoHS compliant.

## **X-ON Electronics**

Largest Supplier of Electrical and Electronic Components

Click to view similar products for RF Switch ICs category:

Click to view products by Analog Devices manufacturer:

Other Similar products are found below:

MASW-008853-TR3000 BGS13SN8E6327XTSA1 BGSX210MA18E6327XTSA1 SKY13446-374LF SW-227-PIN CG2185X2 CG2415M6
MA4SW410B-1 MASW-002102-13580G MASW-008543-001SMB MASW-008955-TR3000 TGS4307 BGS 12PL6 E6327
BGS1414MN20E6327XTSA1 BGS1515MN20E6327XTSA1 BGSA11GN10E6327XTSA1 BGSX28MA18E6327XTSA1 HMC199AMS8
SKY13374-397LF SKY13453-385LF CG2415M6-C2 HMC986A-SX SW-314-PIN UPG2162T5N-E2-A SKY13416-485LF
MASWSS0204TR-3000 MASWSS0201TR MASWSS0181TR-3000 MASW-007588-TR3000 MASW-004103-13655P MASW-00310213590G MASWSS0202TR-3000 MA4SW310B-1 MA4SW110 SW-313-PIN CG2430X1 SKY13321-360LF SKY13405-490LF
SKYA21001 BGSF 18DM20 E6327 SKY13415-485LF MMS008PP3 BGS13PN10E6327XTSA1 SKY13319-374LF
BGS14PN10E6327XTSA1 SKY12213-478LF SKY13404-466LF MASW-011060-TR0500 SKYA21024 SKY85601-11